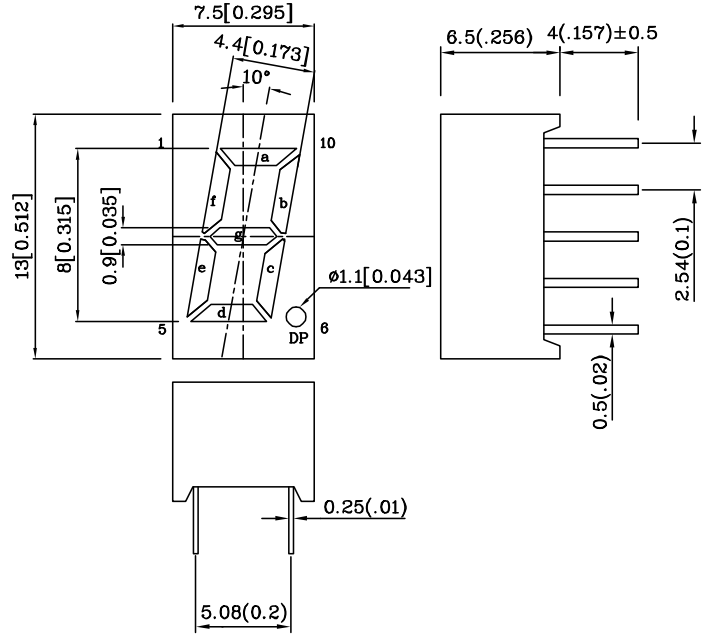
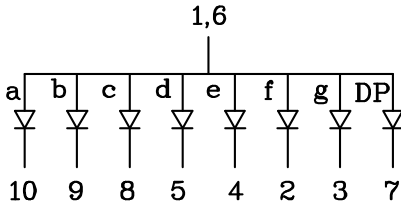


Features

- 0.32 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- STANDARD : GRAY FACE, WHITE SEGMENT
- RoHS COMPLIANT.



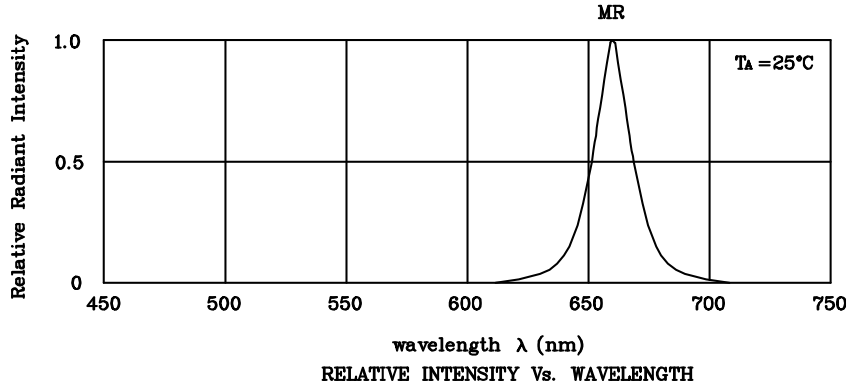
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.

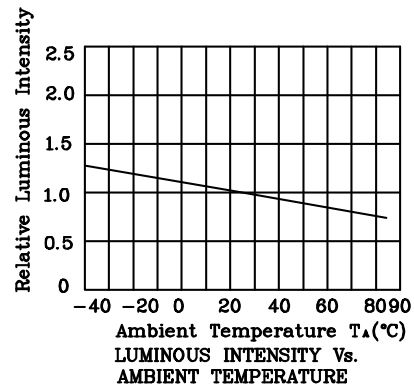
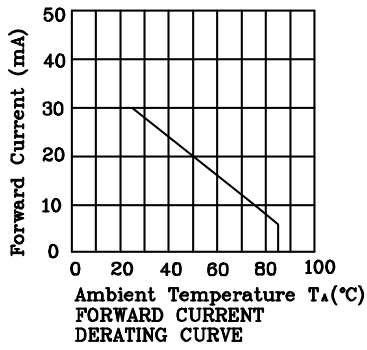
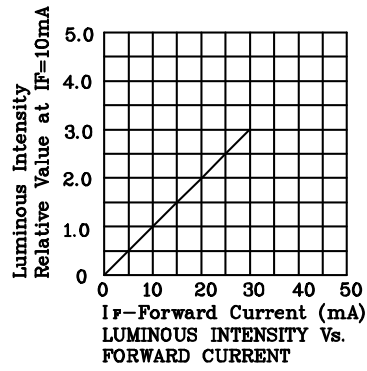
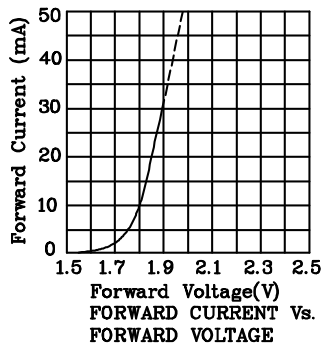
| Absolute Maximum Ratings (TA=25°C) | | MR (GaAlAs) | Unit |
|---------------------------------------------------------------|---------------------|----------------|------|
| Reverse voltage | V _R | 5 | V |
| Forward current | I _F | 30 | mA |
| Forward current (peak) 1/10Duty cycle 0.1ms pulse width | i _{FS} | 155 | mA |
| Power dissipation | P _T | 100 | mW |
| Operating temperature | T _A | -40 ~ +85 | °C |
| Storage temperature | T _{stg} | -40 ~ +85 | |
| Lead solder temperature [2mm below package base] | 260°C For 5 Seconds | | |

| Operating Characteristics (TA=25°C) | | MR (GaAlAs) | Unit |
|-----------------------------------------------------------------------|----------------|----------------|------|
| Forward Voltage (Typ.) (I _F =10mA) | V _F | 1.8 | V |
| Forward Voltage (Max.) (I _F =10mA) | V _F | 2.5 | V |
| Reverse Current (V _R =5V) | I _R | 10 | uA |
| Wavelength of Peak Emission (I _F =10mA) | λ peak | 660 | nm |
| Wavelength of Dominant Emission (I _F =10mA) | λ D | 640 | nm |
| Spectral Line Full Width At Half-Maximum (I _F =10mA) | Δλ | 20 | nm |
| Capacitance (V _F =0V, f=1MHz) | C | 45 | pF |

| Part Number | Emitting Color | Emitting Material | Luminous Intensity (I _F =10mA) ucd | Wavelength nm λ P | Description |
|-------------|----------------|-------------------|--------------------------------------------------|-------------------------|------------------------------|
| | | | min. typ. | | |
| XDMR06A | Red | GaAlAs | 4700 13990 | 660 | Common Anode.Rt.Hand Decimal |

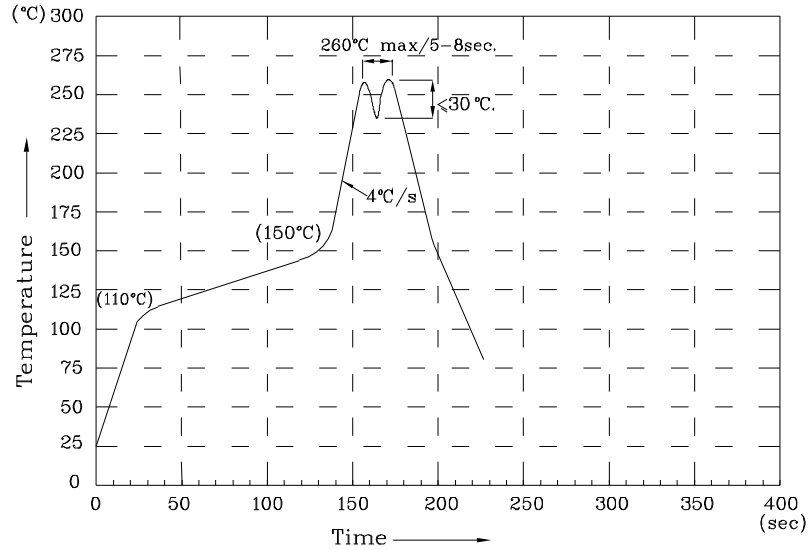


❖ MR



XDMR06A

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85 degree°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.